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### ES2312X-3LID10

### 25Gbps SFP28 Transceiver, Single Mode, 10km Reach

- Supports up to 25.78Gbps bit rates
- Hot-pluggable SFP+ footprint

SFP28

- > 1310nm DFB laser and PIN photodiode, Up to 10km for SMF transmission
- > Compliant with SFP+ MSA and SFF-8472 with duplex LC receptacle
- Compatible with RoHS
- Single +3.3V power supply
- > Real Time Digital Diagnostic Monitoring
- > Operating case temperature:

Industrial: -40 to +85°C

# Applications

- > 25GBASE-LR
- 25G CPRI

### **Description**

The SFP28 transceivers are high performance, cost effective modules supporting data rate of 25.78Gbps and 10km transmission distance with SMF.

The transceiver consists of three sections: a DFB laser transmitter, a PIN photodiode integrated with a trans-impedance preamplifier (TIA) and MCU control unit. All modules satisfy class I laser safety requirements.

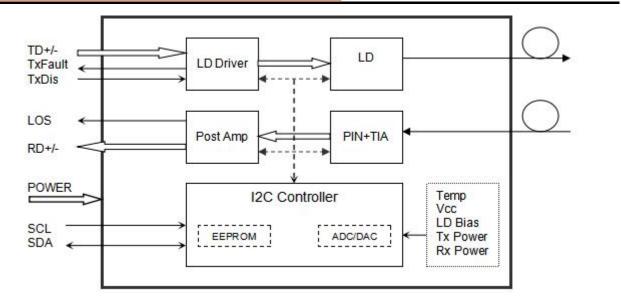
The transceivers are compatible with SFP Multi-Source Agreement and SFF-8472 digital diagnostics functions.

#### Internal CDR's Locking Modes

Bits 110.3 and bits 118.3 control the locking modes of the internal retimer or CDR, default Value is "1".

Bit 110.3 of A2h	Bit 118.3 of A2h	RX Data Rate	TX Data Rate	Status of RX CDR	Status of TX CDR
High/1	High/1	24.33G/25.78G	24.33G/25.78G	CDR select	CDR select
High/1	Low/0	24.33G/25.78G	9.95G/10.31G	CDR select	CDR bypass
Low/0	High/1	9.95G/10.31G	24.33G/25.78G	CDR bypass	CDR select
Low/0	Low/0	9.95G/10.31G	9.95G/10.31G	CDR bypass	CDR bypass

### Transceiver functional diagram



#### Transceiver functional diagram

## **Absolute Maximum Ratings**

Parameter	Symbol	Min	Мах	Unit
Supply Voltage	Vcc	-0.5	4.5	V
Storage Temperature	Ts	-40	+85	°C
Operating Humidity	-	5	85	%

## **Recommended Operating Conditions**

Parameter	Symbol	Min	Typical	Max	Unit
Operating Case Temperature	Тс	-40		+85	°C
Power Supply Voltage	Vcc	3.135	3.30	3.465	V
Power Supply Current	lcc			450	mA
Data Rate			25.78		Gbps

# **Optical and Electrical Characteristics**

Para	neter	Symbol	Min	Typical	Мах	Unit	Notes
	I		Transmi	tter	•		
Centre V	Vavelength	λς	1270	1310	1350	nm	
Spectral W	idth(-20dB)	Δλ			1	nm	
Side-Mode Su	ppression Ratio	SMSR	30	-		dB	
Average C	Output Power	Pout	-7		2	dBm	1
Extinct	ion Ratio	ER	3.5			dB	
Data Input Sv	wing Differential	V <sub>IN</sub>	180		850	mV	2
Input Differer	ntial Impedance	Z <sub>IN</sub>	90	100	110	Ω	
TV Disable	Disable		2.0		Vcc	V	
TX Disable	Enable		0		0.8	V	
	Fault		2.0		Vcc	V	
TX Fault	Normal		0		0.8	V	
			Receiv	er			
Centre V	Vavelength	λς	1260		1600	nm	
Receiver	Sensitivity				-13.3	dBm	3
Receive	r Overload				2	dBm	3
LOSE	LOS De-Assert				-15	dBm	
LOS	Assert	LOSA	-30			dBm	
LOS H	LOS Hysteresis		0.5			dB	
Data Output S	Data Output Swing Differential		300		900	mV	4
	00	High	2.0		Vcc	V	
	.OS	Low			0.8	V	

#### Notes:

1. The optical power is launched into SMF.

2. PECL input, internally AC-coupled and terminated.

3. Measured with a PRBS 2<sup>31</sup>-1 test pattern @25.78Gps, BER ≤5×10<sup>-5</sup>.

4. Internally AC-coupled.

# Timing and Electrical

Parameter	Symbol	Min	Typical	Max	Unit
Tx Disable Negate Time	t_on			2	ms
Tx Disable Assert Time	t_off			100	μs
Time To Initialize, including Reset of Tx Fault	t_init			300	ms
Tx Fault Assert Time	t_fault			100	μs
Tx Disable To Reset	t_reset	10			μs
LOS Assert Time	t_loss_on			100	μs
LOS De-assert Time	t_loss_off			100	μs
Serial ID Clock Rate	f_serial_clock		100	400	KHz
MOD_DEF (0:2)-High	V <sub>H</sub>	2		Vcc	V
MOD_DEF (0:2)-Low	VL			0.8	V

# Diagnostics

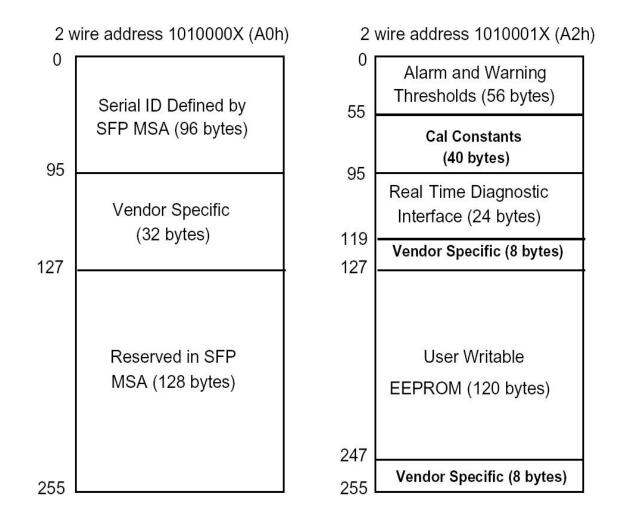
Parameter	Range	Unit	Accuracy	Calibration
Temperature	-40 to +85	°C	±3°C	Internal
Voltage	3.0 to 3.6	V	±3%	Internal
Bias Current	0 to 100	mA	±10%	Internal
TX Power	-7 to 2	dBm	±3dB	Internal
RX Power	-14 to +2	dBm	±3dB	Internal

## **Digital Diagnostic Memory Map**

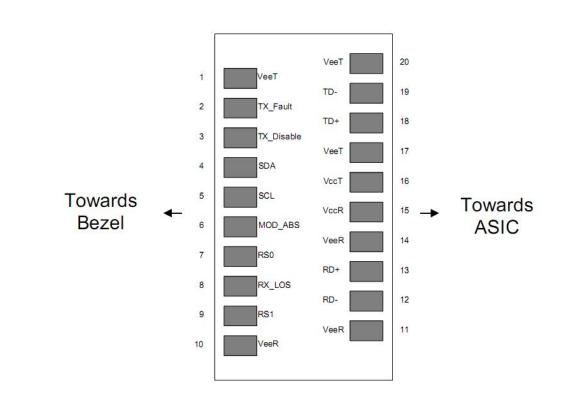
The transceivers provide serial ID memory contents and diagnostic information about the present operating conditions by the 2-wire serial interface (SCL, SDA).

The diagnostic information with internal calibration or external calibration all are implemented, including received power monitoring, transmitted power monitoring, bias current monitoring, supply voltage monitoring and temperature monitoring.

The digital diagnostic memory map specific data field defines as following.



**Pin Definitions** 



# **Pin Descriptions**

Pin	Signal Name	Description	Plug Seq.	Notes
1	VEET	Transmitter Ground	1	
2	TX FAULT	Transmitter Fault Indication	3	Note 1
3	TX DISABLE	Transmitter Disable	3	Note 2
4	SDA	SDA Serial Data Signal	3	
5	SCL	SCL Serial Clock Signal	3	
6	MOD_ABS	Module Absent. Grounded within the module	3	
7	RS0	Not Connected	3	
8	LOS	Loss of Signal	3	Note 3
9	RS1	Not Connected	3	
10	V <sub>EER</sub>	Receiver ground	1	
11	V <sub>EER</sub>	Receiver ground	1	
12	RD-	Inv. Received Data Out	3	Note 4
13	RD+	Received Data Out	3	Note 4
14	V <sub>EER</sub>	Receiver ground	1	
15	V <sub>CCR</sub>	Receiver Power Supply	2	
16	V <sub>CCT</sub>	Transmitter Power Supply	2	

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17	V <sub>EET</sub>	Transmitter Ground	1	
18	TD+	Transmit Data In	3	Note 5
19	TD-	Inv. Transmit Data In	3	Note 5
20	V <sub>EET</sub>	Transmitter Ground	1	

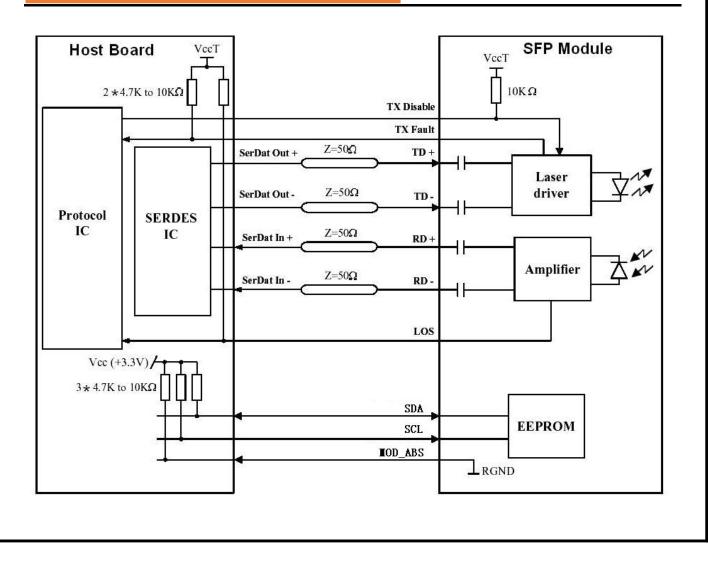
Notes:

Plug Seq.: Pin engagement sequence during hot plugging.

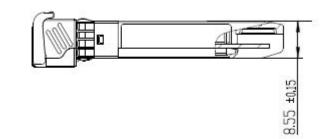
- TX Fault is an open collector output, which should be pulled up with a 4.7k~10kΩ resistor on the host board to a voltage between 2.0V and Vcc+0.3V. Logic 0 indicates normal operation; Logic 1 indicates a laser fault of some kind. In the low state, the output will be pulled to less than 0.8V.
- 2) Laser output disabled on TDIS >2.0V or open, enabled on TDIS <0.8V.
- 3) LOS is open collector output. Should be pulled up with 4.7k~10kΩ on host board to a voltage between 2.0V and 3.6V. Logic 0 indicates normal operation; logic 1 indicates loss of signal.
- 4) RD-/+: These are the differential receiver outputs. They are internally AC-coupled 100 differential lines which should be terminated with 100Ω (differential) at the user SERDES.

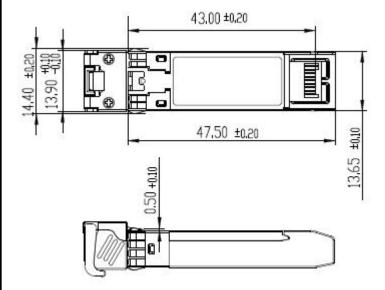
5) TD-/+: These are the differential transmitter inputs. They are internally AC-coupled, differential lines with  $100\Omega$  differential termination inside the module.

### **Recommended Interface Circuit**



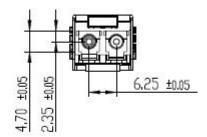
# **Mechanical Dimensions**







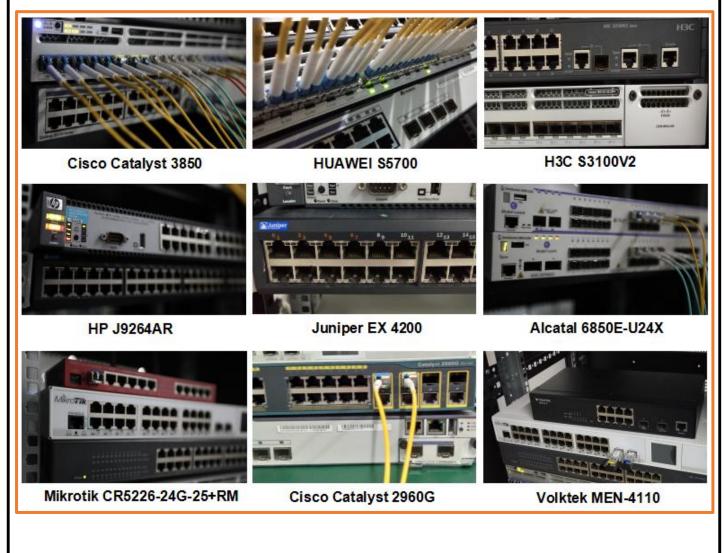
Part Number	Product Description
ES2312X-3LID10	1310nm, 25.78Gbps, LC, 10km, -40°C~+85°C, with DDM



### **Compatibility Test**

In order to ensure the product compatibility, our products will be tested on the switch before shipment. Our modules can compatible with many mainstream brand switches, such as Cisco, Juniper, Extreme, Brocade, IBM, H3C, HP, Huawei, D-Link, Mikrotik, ZTE, TP-Link...

Our test equipment: VOLKTEK MEN-4110, HP 2530-8G, CRS226-24G-25+RM, Catalyst 2960G Series, Catalyst 3850 XS 10G SFP+, Catalyst 3750-E Series, HUAWEI S5700Series, H3C S3100V2 Series, Juniper-EX4200, etc.



### **Product Production Process**

# **Quality Assurance**

Continuous introduction of new equipment, produced by strict standards, strict quality inspection, to guarantee the high quality standard of each product.



**Product Initial Test** 

Switch Testing

**Product Final Test** 

